

2SB1440

Silicon PNP epitaxial planar type

For low-frequency output amplification Complementary to 2SD2185

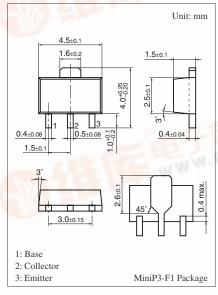
■ Features

- ullet Low collector to emitter saturation voltage $V_{CE(sat)}$.
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit |
|-------------------------------|------------------|-------------|------|
| Collector to base voltage | V _{CBO} | -50 | V |
| Collector to emitter voltage | V _{CEO} | -50 | V |
| Emitter to base voltage | V _{EBO} | -5 | V |
| Peak collector current | I_{CP} | -3 | A |
| Collector current | I_{C} | -2 | A |
| Collector power dissipation * | P_{C} | 1 | W |
| Junction temperature | T _j | 150 | °C |
| Storage temperature | T_{stg} | -55 to +150 | °C |

Note) *: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion.



Marking Symbol: 11

■ Electrical Characteristics T_a = 25°C

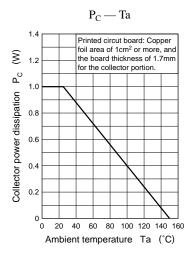
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------------------|--|-----|--------|-------|------|
| Collector to base voltage | V_{CBO} | $I_C = -10 \ \mu A, I_E = 0$ | -50 | | 144 | V |
| Collector to emitter voltage | V_{CEO} | $I_{\rm C} = -1 \text{mA}, I_{\rm B} = 0$ | -50 | | | V |
| Emitter to base voltage | V_{EBO} | $I_{\rm E} = -10 \; \mu \text{A}, \; I_{\rm C} = 0$ | -5 | | - 4 | V |
| Collector cutoff current | I_{CBO} | $V_{CB} = -20 \text{ V}, I_E = 0$ | | | - 0.1 | μΑ |
| Forward current transfer ratio *1 | h _{FE1} *2 | $V_{CE} = -2 \text{ V}, I_{C} = -200 \text{ mA}$ | 120 | | 340 | |
| | h _{FE2} | $V_{CE} = -2 \text{ V}, I_{C} = -1 \text{ A}$ | 60 | | | |
| Collector to emitter saturation voltage *1 | V _{CE(sat)} | $I_C = -1 \text{ A}, I_B = -50 \text{ mA}$ | | - 0.2 | - 0.3 | V |
| Base to emitter saturation voltage *1 | V _{BE(sat)} | $I_C = -1 \text{ A}, I_B = -50 \text{ mA}$ | | - 0.85 | -1.2 | V |
| Transition frequency | f_T | $V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$ | | 150 | | MHz |
| Collector output capacitance | C _{ob} | $V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ | | 45 | 60 | pF |

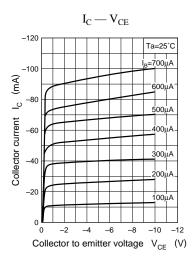
Note) *1: Pulse measurement

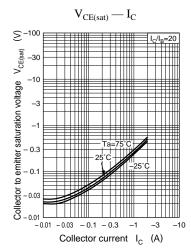
*2: hFE1 Rank classification

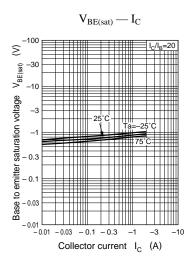
| Rank | R | S |
|------------------|------------|------------|
| h _{FE1} | 120 to 240 | 170 to 340 |

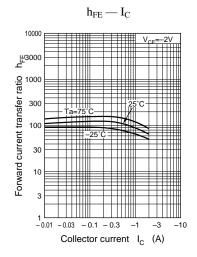
2SB1440 Panasonic

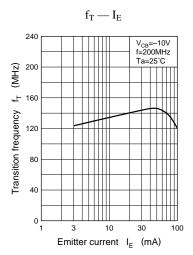


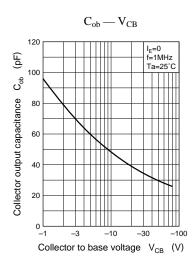












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